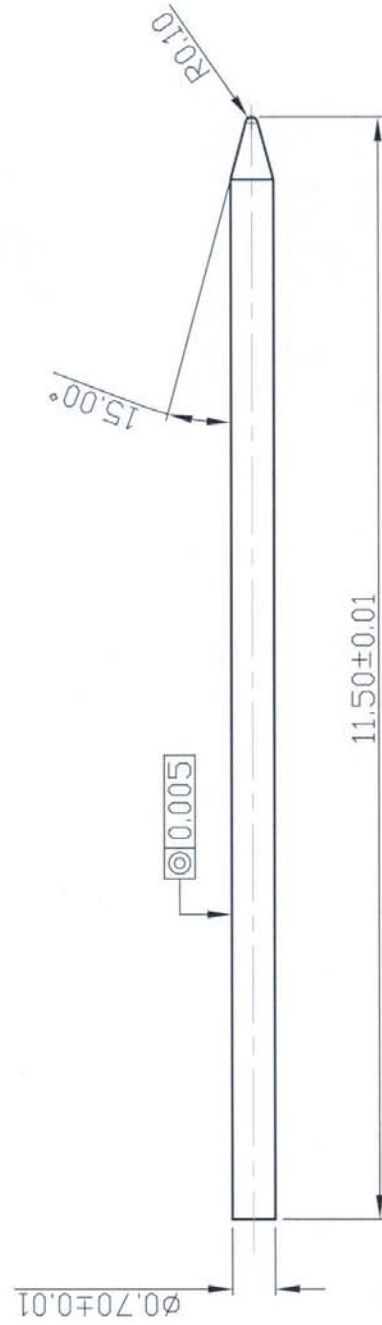




REMARKS : USE ON SEMICONDUCTOR
DIE ATTACHMENT PROCESS.

DESCRIPTION		PLASTIC EJECTOR NEEDLE	
TOLERANCES EXCEPT WHERE OTHERWISE STATED		TEC-TOOLS SERVICES	
INCHES FRAC:1/64" DEC. 0.05		MATERIAL	
MILLEMETER0.xxx ±0.005mm		DRAWN BY	
0.xx ±0.02mm		L. S. CHAN	
0.x ±0.10mm		CHECK BY	
OTHERS		DATE	
ANGULARS ±1/2° FINISHING		03/08/2004	
		SCALE	
		NTS	
		DVG NO	
		T042-2022	
		REV.	
		00	

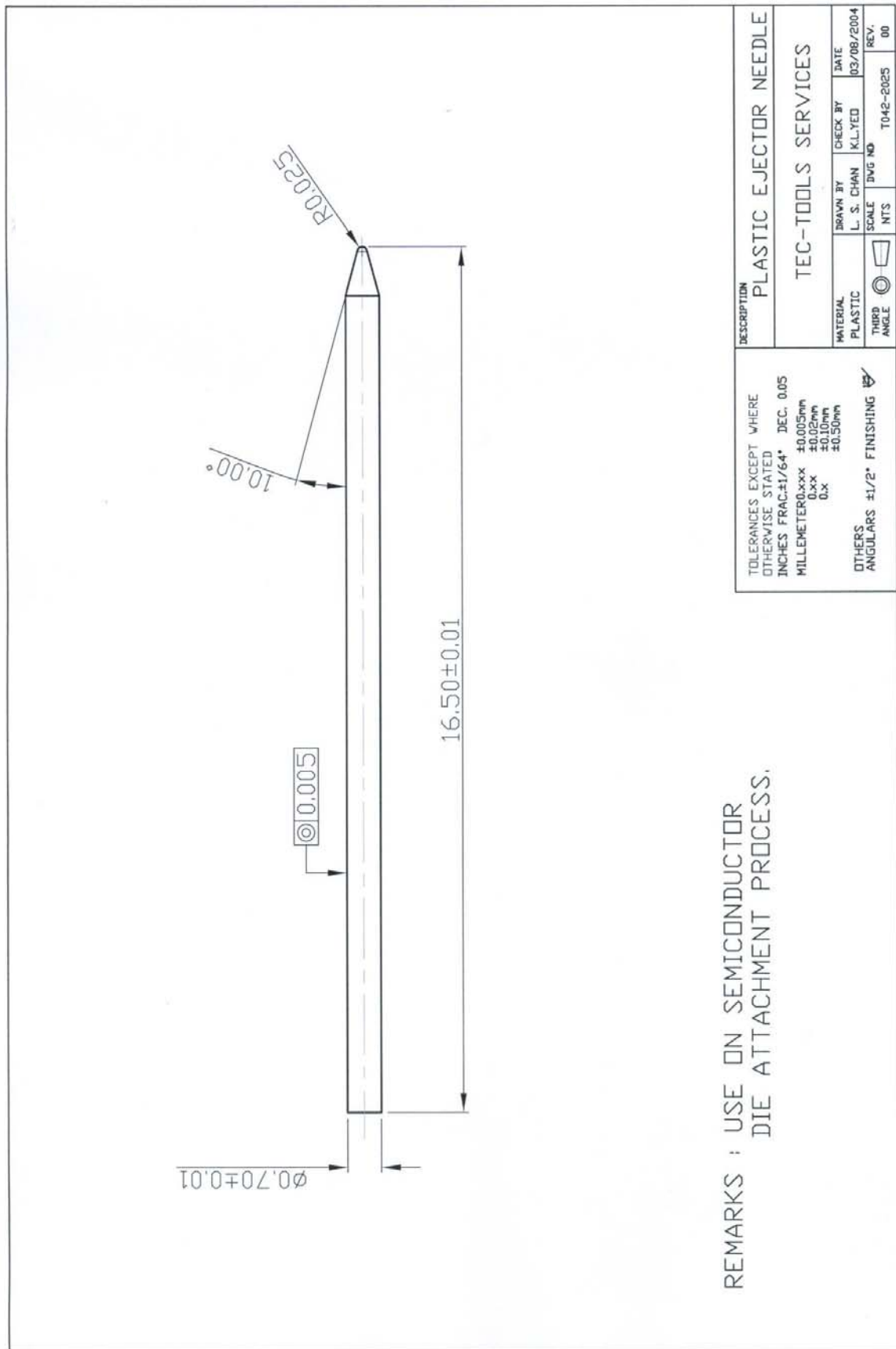


FIG.2

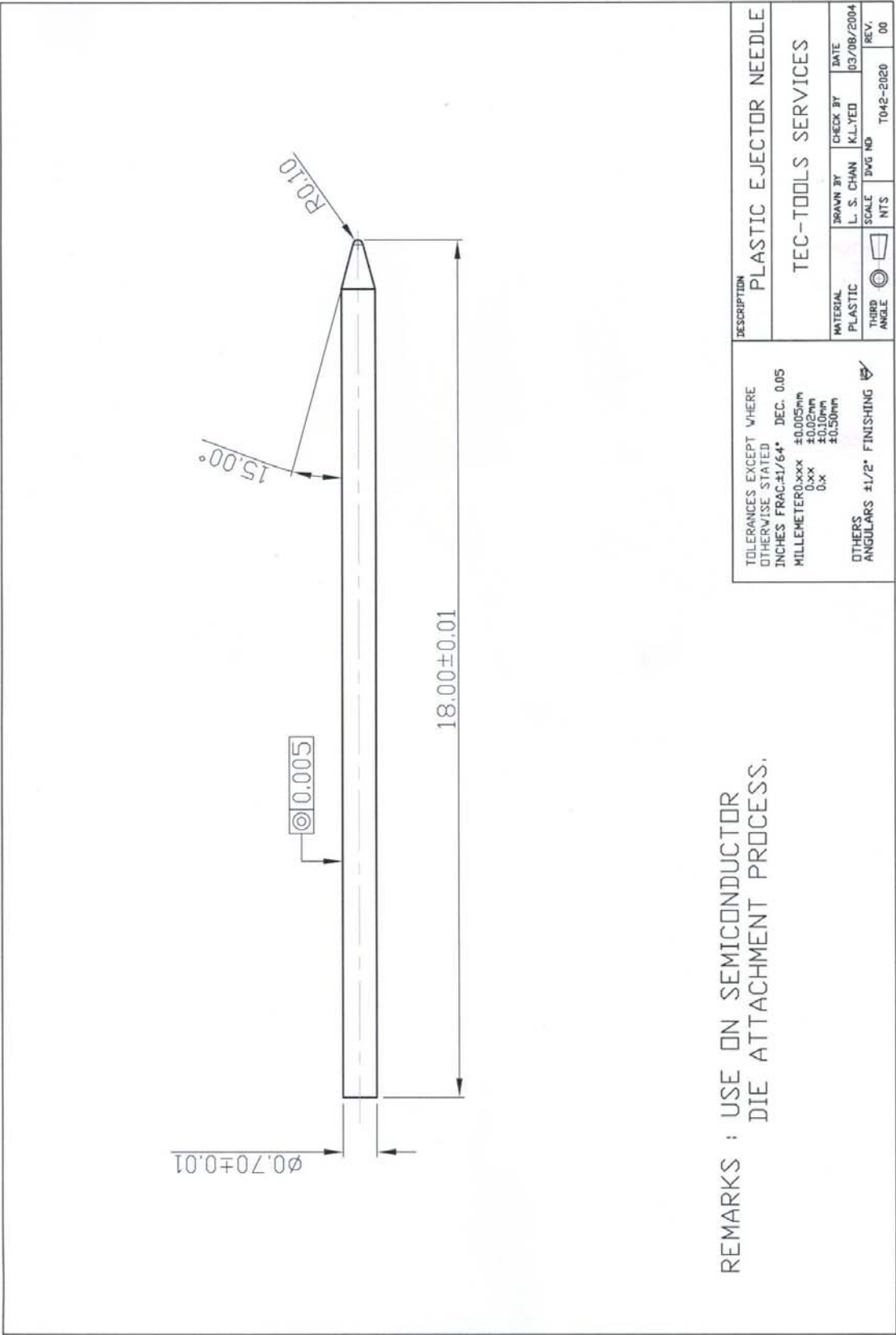


FIG.3

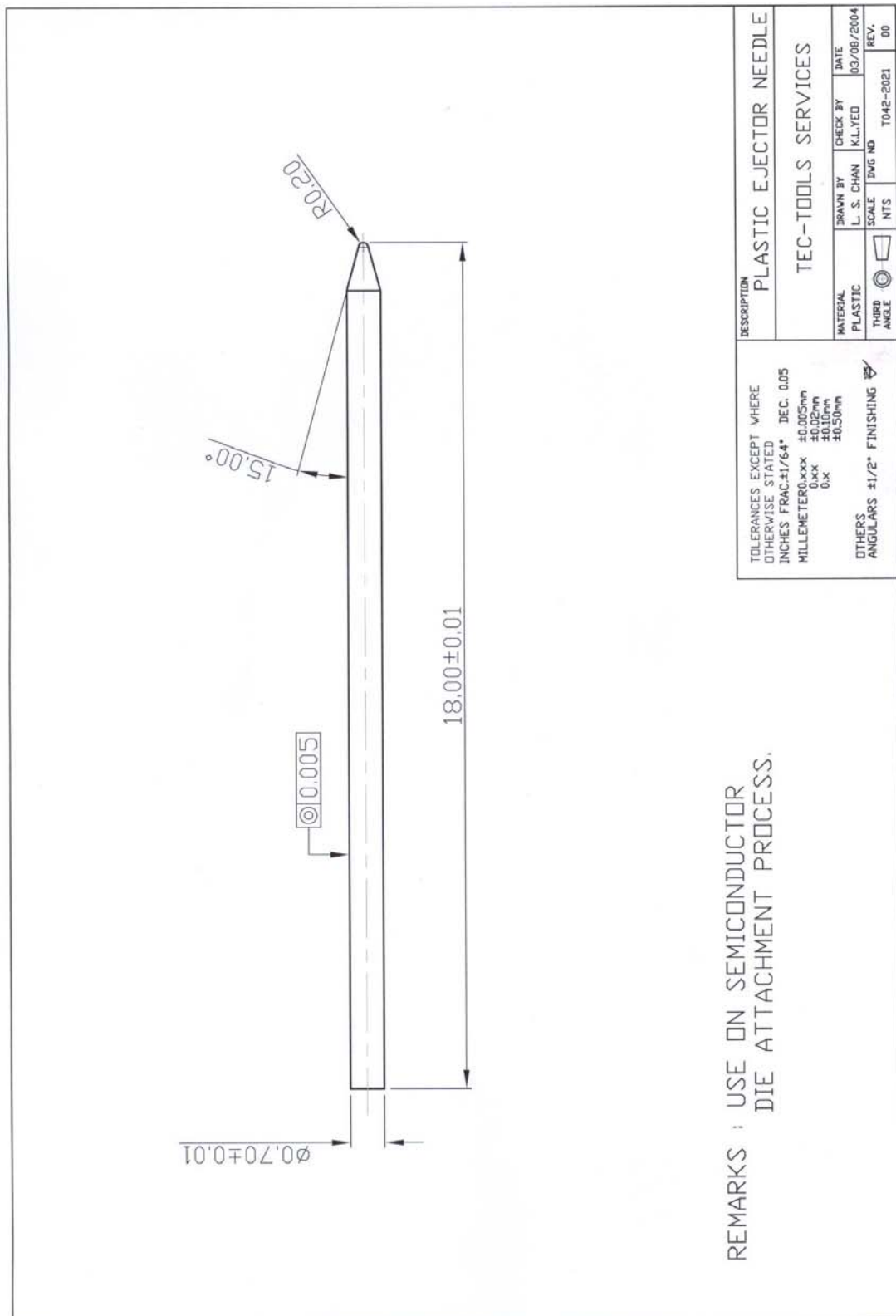
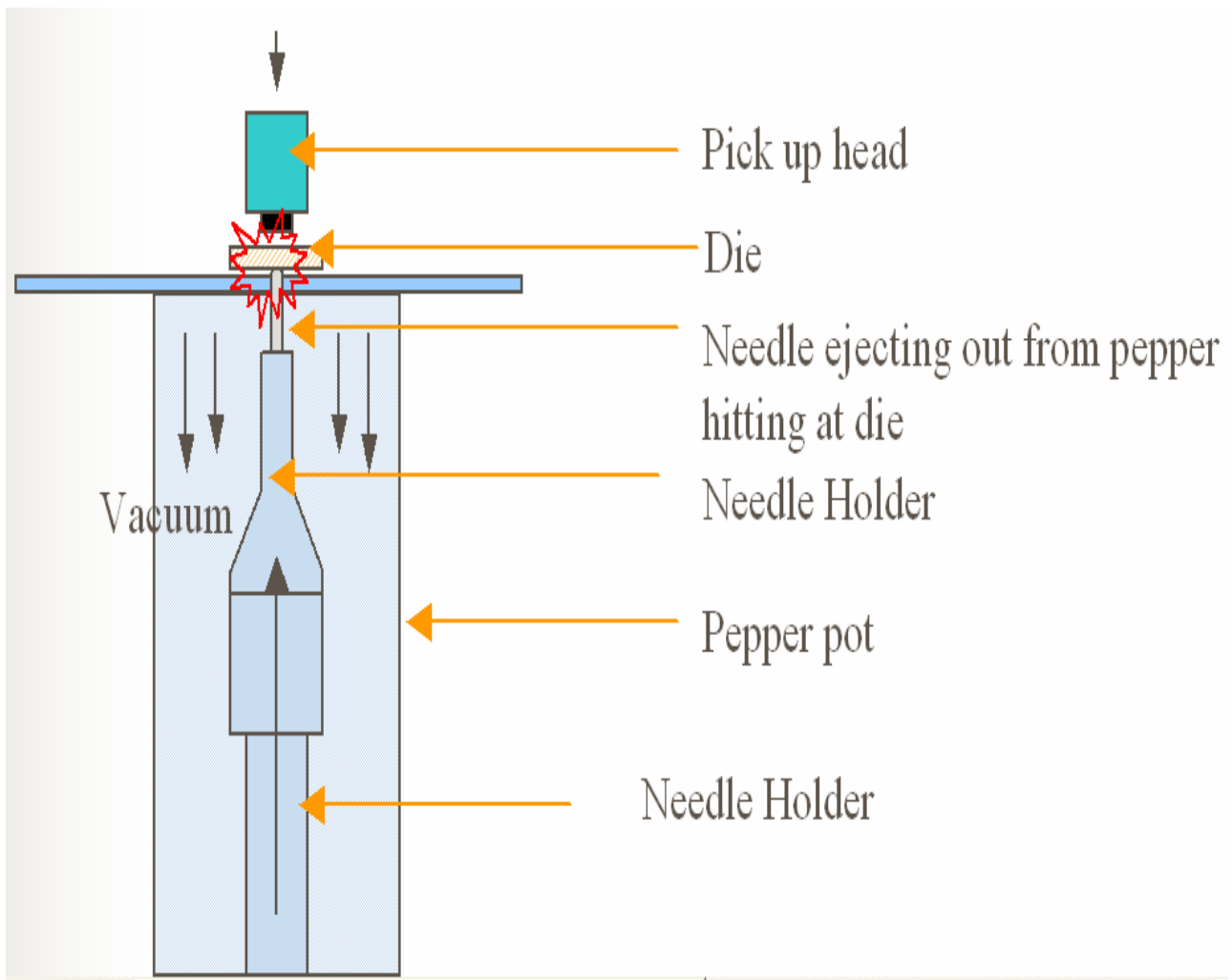


FIG.4

**FIG. 5**